

## 54ABT373

# Octal Transparent Latch with TRI-STATE® Outputs

#### **General Description**

The 'ABT373 consists of eight latches with TRI-STATE outputs for bus organized system applications. The flip-flops appear transparent to the data when Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup times is latched. Data appears on the bus when the Output Enable  $(\overline{OE})$  is LOW. When  $\overline{OE}$  is HIGH the bus output is in the high impedance state.

#### **Features**

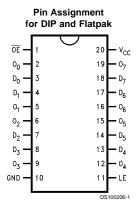
- TRI-STATE outputs for bus interfacing
- Output sink capability of 48 mA, source capability of

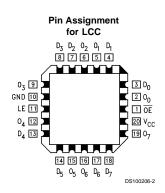
- Guaranteed multiple output switching specifications
- Output switching specified for both 50 pF and 250 pF loads
- Guaranteed simultaneous switching, noise level and dynamic threshold performance
- Guaranteed latchup protection
- High impedance glitch free bus loading during entire power up and power down
- Nondestructive hot insertion capability
- Standard Microcircuit Drawing (SMD) 5962-9321801

### **Ordering Code**

Military	Package Number	Package Description
54ABT373J-QML	J20A	20-Lead Ceramic Dual-In-Line
54ABT373W-QML	W20A	20-Lead Cerpack
54ABT373E-QML	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C

# **Connection Diagrams**





Pin Names	Description
D <sub>0</sub> -D <sub>7</sub>	Data Inputs
LE	Latch Enable Input
	(Active HIGH)
ŌĒ	Output Enable Input
	(Active LOW)
O <sub>0</sub> -O <sub>7</sub>	TRI-STATE Latch
	Outputs

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## **Functional Description**

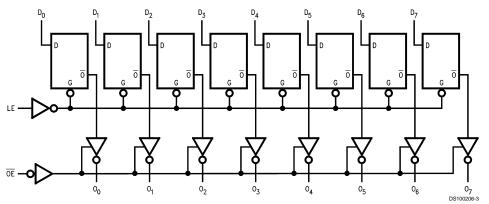
The 'ABT373 contains eight D-type latches with TRI-STATE output buffers. When the Latch Enable (LE) input is HIGH, data on the  $D_n$  inputs enters the latches. In this condition the latches are transparent, i.e., a latch output will change state each time its D input changes. When LE is LOW, the latches store the information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LE. The TRI-STATE buffers are controlled by the Output Enable (OE) input. When  $\overline{OE}$  is LOW, the buffers are in the bi-state mode. When  $\overline{\text{OE}}$  is HIGH the buffers are in the high impedance mode but this does not interfere with entering new data into the latches.

#### **Truth Table**

Inputs			Output
LE OE D <sub>n</sub>		O <sub>n</sub>	
Н	L	Н	Н
Н	L	L	L
L	L	Х	O <sub>n</sub> (no change)
Х	Н	Х	Z

- H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial
- Z = High Impedance State

### **Logic Diagram**



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Storage Temperature -65°C to +150°C

Ambient Temperature under Bias -55°C to +125°C

Junction Temperature under Bias

-55°C to +175°C Ceramic

V<sub>CC</sub> Pin Potential to Ground Pin -0.5V to +7.0VInput Voltage (Note 2) -0.5V to +7.0V Input Current (Note 2) -30 mA to +5.0 mA

Voltage Applied to Any Output

in the Disabled or

Power-Off State -0.5V to +5.5V –0.5V to  $V_{\mbox{\scriptsize CC}}$ in the HIGH State

Current Applied to Output in LOW State (Max) twice the rated I<sub>OL</sub> (mA) Over Voltage Latchup (I/O)

10V

### **Recommended Operating** Conditions

Free Air Ambient Temperature

-55°C to +125°C Military

Supply Voltage Military

+4.5V to +5.5V

Minimum Input Edge Rate  $(\Delta V/\Delta t)$ Data Input 50 mV/ns Enable Input 20 mV/ns

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

#### **DC Electrical Characteristics**

Symbol	Symbol Parameter		ABT373		Units	V <sub>cc</sub>	Conditions	
			Min	Тур	Max	1		
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized HIGH Signal
V <sub>IL</sub>	Input LOW Voltage				0.8	V		Recognized LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltag	е			-1.2	V	Min	I <sub>IN</sub> = -18 mA
V <sub>OH</sub>	Output HIGH Voltage	54ABT	2.5					I <sub>OH</sub> = -3 mA
		54ABT	2.0			V	Min	I <sub>OH</sub> = -24 mA
V <sub>OL</sub>	Output LOW Voltage 54ABT				0.55	V	Min	I <sub>OL</sub> = 48 mA
I <sub>IH</sub>	Input HIGH Current				5	μA	Max	V <sub>IN</sub> = 2.7V (Note 4)
					5			V <sub>IN</sub> = V <sub>CC</sub>
I <sub>BVI</sub>	Input HIGH Current Break	down Test			7	μA	Max	V <sub>IN</sub> = 7.0V
I <sub>IL</sub>	Input LOW Current				-5	μΑ	Max	V <sub>IN</sub> = 0.5V (Note 4)
					-5			V <sub>IN</sub> = 0.0V
V <sub>ID</sub>	Input Leakage Test		4.75			V	0.0	I <sub>ID</sub> = 1.9 μA
								All Other Pins Grounded
I <sub>OZH</sub>	Output Leakage Current				50	μA	0 - 5.5V	V <sub>OUT</sub> = 2.7V; <del>OE</del> = 2.0V
I <sub>OZL</sub>	Output Leakage Current				-50	μA	0 - 5.5V	V <sub>OUT</sub> = 0.5V; <del>OE</del> = 2.0V
I <sub>OS</sub>	Output Short-Circuit Curre	ent	-100		-275	mA	Max	V <sub>OUT</sub> = 0.0V
I <sub>CEX</sub>	Output High Leakage Cur	rent			50	μA	Max	V <sub>OUT</sub> = V <sub>CC</sub>
I <sub>ZZ</sub>	Bus Drainage Test				100	μA	0.0	V <sub>OUT</sub> = 5.5V; All Others GND
I <sub>CCH</sub>	Power Supply Current				50	μA	Max	All Outputs HIGH
I <sub>CCL</sub>	Power Supply Current				30	mA	Max	All Outputs LOW
I <sub>CCZ</sub>	Power Supply Current				50	μΑ	Max	OE = V <sub>CC</sub>
								All Others at V <sub>CC</sub> or GND
I <sub>CCT</sub>	Additional I <sub>CC</sub> /Input	Outputs Enabled			2.5	mA		V <sub>I</sub> = V <sub>CC</sub> - 2.1V
		Outputs TRI-STATE			2.5	mA	Max	Enable Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V
		Outputs TRI-STATE			2.5	mA		Data Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V
								All Others at V <sub>CC</sub> or GND
I <sub>CCD</sub>	Dynamic I <sub>CC</sub> No Load					mA/	Max	Outputs Open, LE = V <sub>CC</sub>
	(Note 4)				0.12	MHz		OE = GND, (Note 3)
								One Bit Toggling, 50% Duty Cycle

Note 3: For 8 bits toggling,  $I_{CCD}$  < 0.8 mA/MHz.

Note 4: Guaranteed, but not tested.

Symbol	Parameter	54/	ABT	Units
		$T_A = -55^{\circ}$	C to +125°C	
		V <sub>CC</sub> = 4.5V to 5.5V C <sub>L</sub> = 50 pF		
		Min	Max	
t <sub>PLH</sub>	Propagation Delay	1.0	6.8	ns
t <sub>PHL</sub>	D <sub>n</sub> to O <sub>n</sub>	1.0	7.0	
t <sub>PLH</sub>	Propagation Delay	1.0	7.7	ns
t <sub>PHL</sub>	LE to O <sub>n</sub>	1.5	7.7	
t <sub>PZH</sub>	Output Enable Time	1.0	6.7	ns
t <sub>PZL</sub>		1.5	7.2	
t <sub>PHZ</sub>	Output Disable Time	1.7	8.0	ns
t <sub>PLZ</sub>		1.0	7.0	

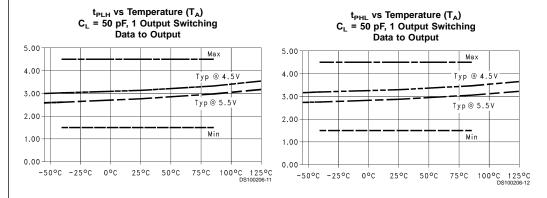
# **AC Operating Requirements**

Symbol	Parameter	54/	54ABT T <sub>A</sub> = -55°C to +125°C	
		$T_A = -55^{\circ}$		
		$V_{CC} = 4.5V \text{ to } 5.5V$		
		C <sub>L</sub> = 50 pF		
		Min	Max	
t <sub>s</sub> (H)	Setup Time, HIGH	2.5		ns
t <sub>s</sub> (L)	or LOW D <sub>n</sub> to LE	2.5		
t <sub>h</sub> (H)	Hold Time, HIGH	2.5		ns
t <sub>h</sub> (L)	or LOW D <sub>n</sub> to LE	2.5		
t <sub>w</sub> (H)	Pulse Width,	3.3		ns
	LE HIGH			

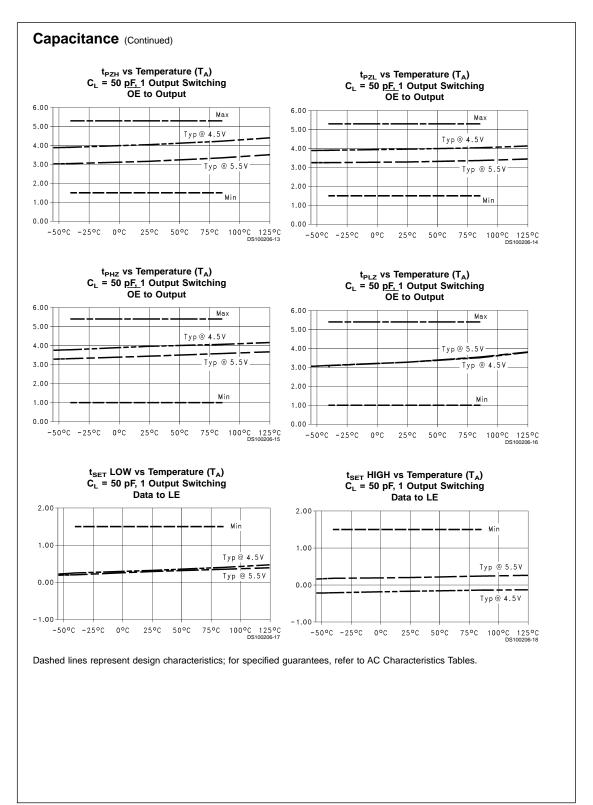
# Capacitance

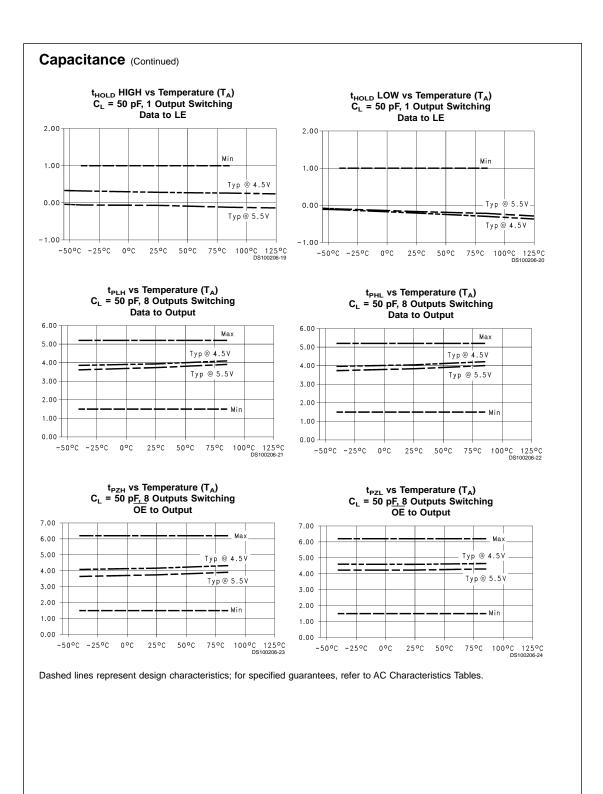
Symbol	Parameter	Тур	Units	Conditions
				(T <sub>A</sub> = 25°C)
C <sub>IN</sub>	Input Capacitance	5	pF	V <sub>CC</sub> = 0V
C <sub>OUT</sub> (Note 5)	Output Capacitance	9	pF	V <sub>CC</sub> = 5.0V

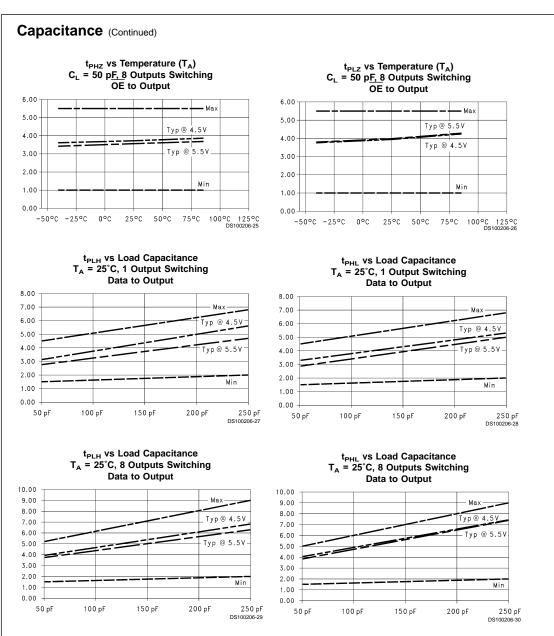
Note 5: C<sub>OUT</sub> is measured at frequency f = 1 MHz, per MIL-STD-883B, Method 3012.



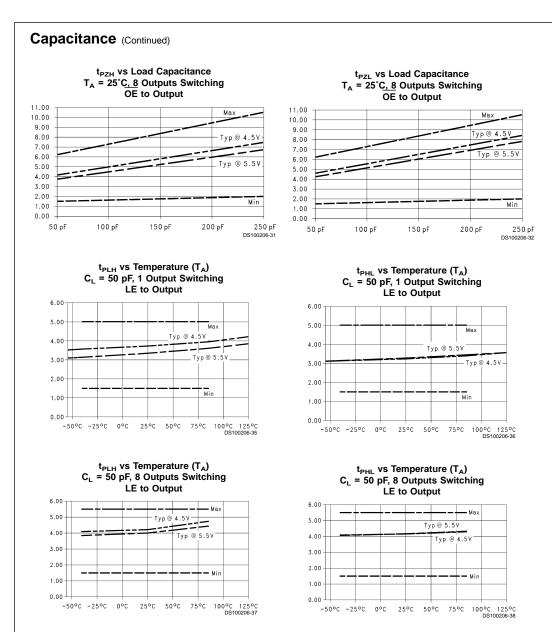
Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.







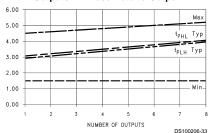
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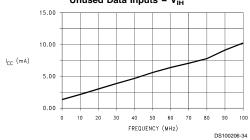
Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.

## Capacitance (Continued)

 $t_{PLH}$  and  $t_{PHL}$  vs Number Outputs Switching  $C_L$  = 50 pF,  $T_A$  = 25°C,  $V_{CC}$  = 5.0V, Outputs In Phase Data to Output

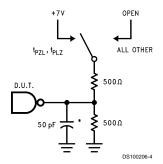


Typical  $I_{CC}$  vs Output Switching Frequency  $C_L = 0$  pF,  $V_{CC} = V_{IH} = 5.5$ V, LE = GND, 1 Output Switching at 50% Duty Cycle Data to Output, Transparent Mode with Unused Data Inputs =  $V_{IH}$ 



Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.

# **AC Loading**



\*Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load

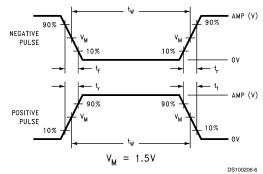


FIGURE 2. Test Input Signal Levels

Amplitude	Rep. Rate	t <sub>w</sub>	t <sub>r</sub>	t <sub>f</sub>
3.0V	1 MHz	500 ns	2.5 ns	2.5 ns

FIGURE 3. Test Input Signal Requirements

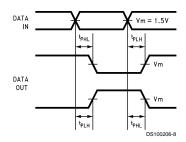


FIGURE 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions

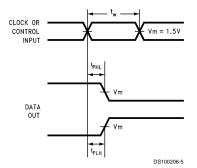


FIGURE 5. Propagation Delay, Pulse Width Waveforms

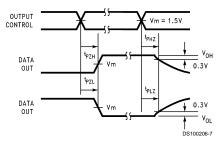


FIGURE 6. TRI-STATE Output HIGH and LOW Enable and Disable Times

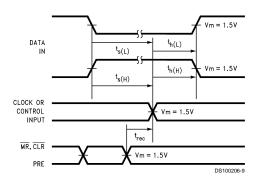
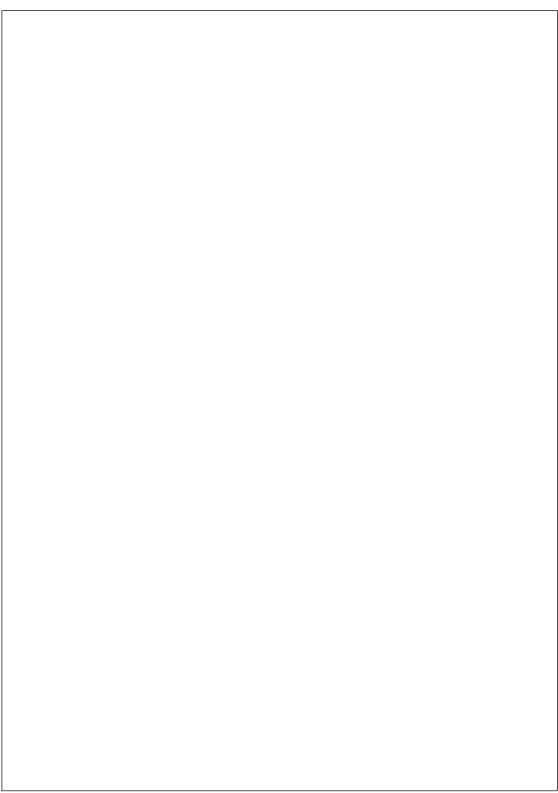
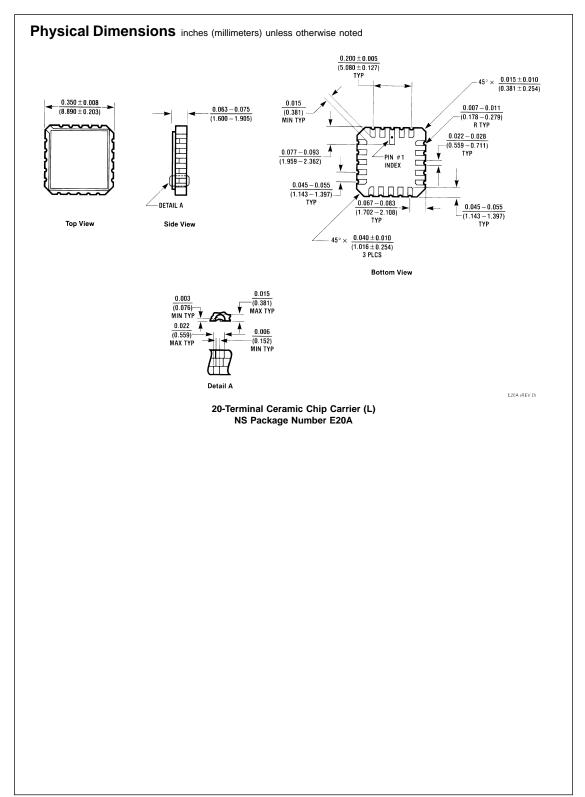
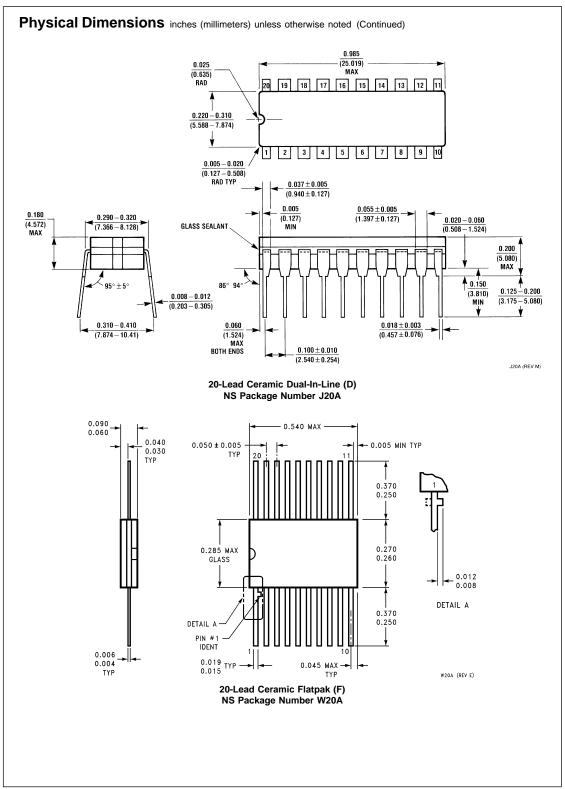


FIGURE 7. Setup Time, Hold Time and Recovery Time Waveforms







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